

67,200-262; TSMC 99-545  
Serial Number 09/588,788

## AMENDMENTS

### *In the Specification*

Please replace the existing Cross-Reference to Related Application with the following Cross-Reference to Related Application.

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### CROSS-REFERENCE TO RELATED APPLICATION

AI This application is related to co-assigned application serial number 09/821,521, filed 29 March 2001, attorney docket number 67,200-261, titled "Planar Spiral Inductor Structure With Patterned Interconnected Bond Pad Region Integral Thereto," the disclosure and references from which related co-assigned application are incorporated herein fully by reference.

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### *In the Claims*

✓ Please cancel claims 9-15.

## REMARKS

Favorable reconsideration of this application in light of the above amendments and the following remarks is respectfully requested.

Claims 1-8 are pending in this application. No claims are amended herein.  
Claims 9-15 are canceled herein. No claims have been allowed.